

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	§	Confirmation No.:	5214
Aron T. Lunde	§		
	§	Group Art Unit:	2823
Application No.:	§		
10/053,963	§	Examiner:	Nguyen, Khiem D.
	§		
Filed:	§		
January 22, 2002	§		
	§	Atty. Docket:	MICS:0214/FLE/MAN/EUB
For: A DIE ASSEMBLY AND METHOD	§		01-0596
FOR FORMING A DIE ON A	§		
WAFER	§		

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October 1, 2007

/Lee Eubanks/

Date

L. Lee Eubanks IV

**AMENDMENT AND RESPONSE TO
OFFICE ACTION MAILED AUGUST 6, 2007**

Dear Sir:

In response to the Final Office Action mailed on August 6, 2007, Applicant respectfully requests reconsideration of the present application in view of the following amendments and remarks.